

## Application Data Sheet

### Application Information

Application number::

Filing Date::

Application Type::

Regular

Subject Matter::

Utility

Title ::

MANUFACTURING METHOD  
OF SEMICONDUCTOR  
DEVICE, AND IC CARD, IC  
TAG, RFID, TRANSPONDER,  
BILL, SECURITIES,  
PASSPORT, ELECTRONIC  
APPARATUS, BAG, AND  
GARMENT

Attorney Docket Number::

0756-7787

Total Drawing Sheets::

28

Small Entity?::

No

### Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Japan

Given Name::

Jun

Middle Name::

Family Name::

KOYAMA

Name Suffix::

City of Residence::

Sagamihara

State or Province of Residence::

Kanagawa

Country of Residence:: Japan  
Street of mailing address:: c/o Semiconductor Energy  
Laboratory Co., Ltd.  
398, Hase  
Atsugi-shi  
City of mailing address:: Kanagawa-ken  
State or Province of mailing address:: Japan  
Country of mailing address::  
Postal or Zip Code of mailing address:: 243-0036

## Correspondence Information

Correspondence Customer Number :: 31780  
E-Mail address:: erobinson@ripl.com

## Representative Information

Representative Customer Number:: 31780

## Domestic Priority Information

Application ::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	National Stage	PCT/JP2005/002680	02/15/2005

## Foreign Priority Information

Country::	Application number::	Filing Date::	Priority Claimed::
Japan	2004-045480	02/20/2004	Yes

## Assignee Information

Assignee name::	Semiconductor Energy Laboratory Co., Ltd.
Street of mailing address::	398 Hase
City of mailing address::	Atsugi-shi
State or Province of mailing address::	Kanagawa-ken
Country of mailing address::	Japan
Postal or Zip Code of mailing address::	243-0036